BT151 series L and R Thyristors

Rev. 04 — 23 October 2006

**Product data sheet** 

High bidirectional blocking voltage

Static switching

I<sub>T(RMS)</sub> ≤ 12 A

I<sub>T(AV)</sub>  $\leq$  7.5 A

SOT78 (3-lead TO-220AB)

Protection circuits

I<sub>TSM</sub>  $\leq$  120 A (t = 10 ms)

I<sub>GT</sub>  $\leq$  5 mA (BT151 series L)

I<sub>GT</sub>  $\leq$  15 mA (BT151 series R)

# 1. Product profile

## 1.1 General description

Passivated thyristors in a SOT78 plastic package.

## 1.2 Features

High thermal cycling performance

## 1.3 Applications

- Motor control
- Ignition circuits

## 1.4 Quick reference data

- V<sub>DRM</sub> ≤ 500 V (BT151-500L/R)
- V<sub>RRM</sub> ≤ 500 V (BT151-500L/R)
- V<sub>DRM</sub> ≤ 650 V (BT151-650L/R)
- $V_{RRM} \le 650 \text{ V} (BT151-650L/R)$
- $V_{DRM} \le 800 \text{ V} (BT151-800R)$
- V<sub>RRM</sub> ≤ 800 V (BT151-800R)

# 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	cathode (K)		N 1
2	anode (A)	mb	А – 🕂 К
3	gate (G)	r O S	G sym037
mb	mounting base; connected to anode		



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## 3. Ordering information

Type number	Package		
	Name	Description	Version
BT151-500L	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78
BT151-500R		3-lead TO-220AB	
BT151-650L			
BT151-650R			
BT151-800R			

# 4. Limiting values

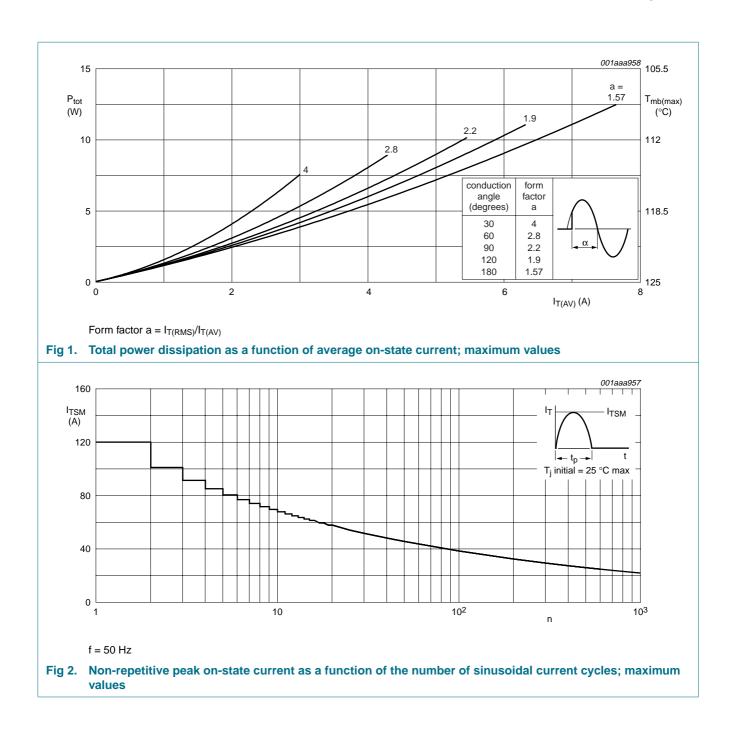
#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

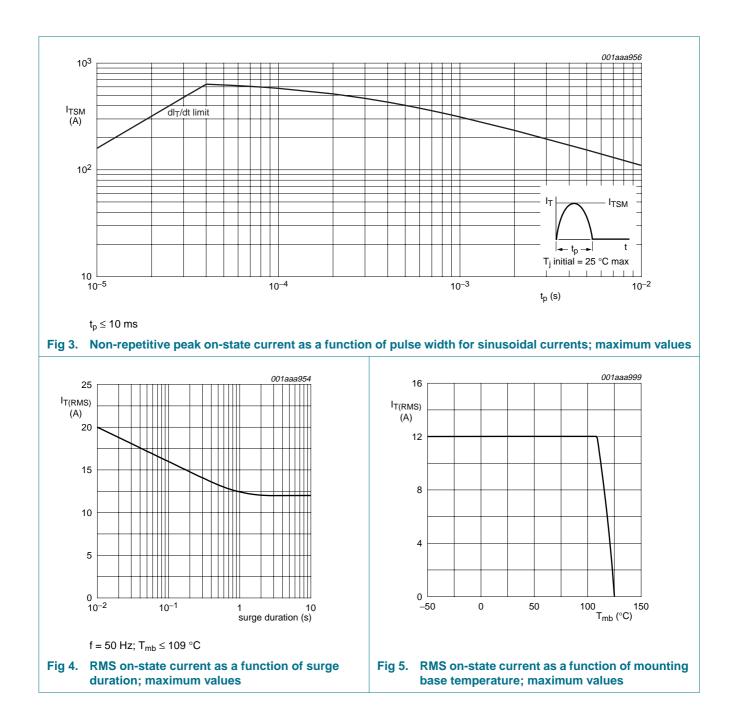
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage	BT151-500L; BT151-500R	[1]	-	500	V
		BT151-650L; BT151-650R	[1]	-	650	V
		BT151-800R		-	800	V
V <sub>RRM</sub>	repetitive peak reverse voltage	BT151-500L; BT151-500R	[1]	-	500	V
		BT151-650L; BT151-650R	[1]	-	650	V
		BT151-800R		-	800	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>mb</sub> ≤ 109 °C; see <u>Figure 1</u>		-	7.5	А
I <sub>T(RMS)</sub>	RMS on-state current	all conduction angles; see $\frac{\text{Figure 4}}{\text{and 5}}$		-	12	А
	non-repetitive peak on-state current	half sine wave; $T_j = 25 \text{ °C}$ prior to surge; see Figure 2 and 3				
		t = 10 ms		-	120	А
		t = 8.3 ms		-	132	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms		-	72	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_{TM}$ = 20 A; $I_G$ = 50 mA; dI <sub>G</sub> /dt = 50 mA/µs		-	50	A/μs
I <sub>GM</sub>	peak gate current			-	2	А
V <sub>RGM</sub>	peak reverse gate voltage			-	5	V
P <sub>GM</sub>	peak gate power			-	5	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period		-	0.5	W
T <sub>stg</sub>	storage temperature			-40	+150	°C
Tj	junction temperature			-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

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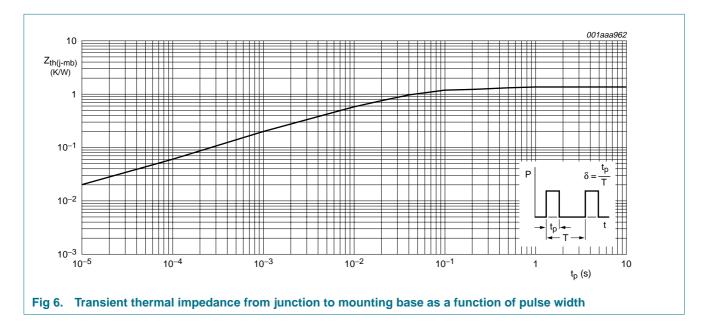
Table

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## 5. Thermal characteristics

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Table 4.	I hermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 6	-	-	1.3	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	60	-	K/W

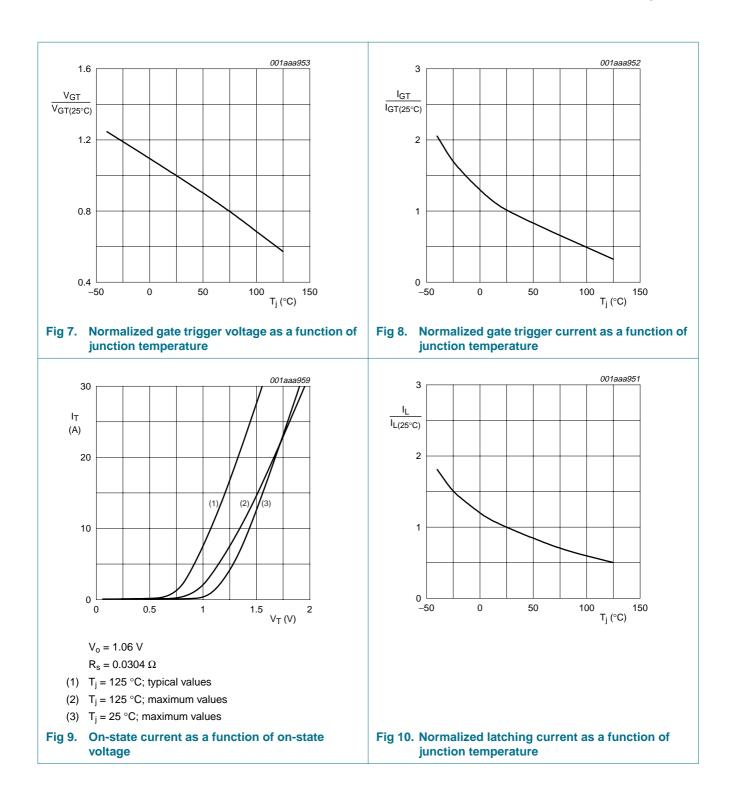


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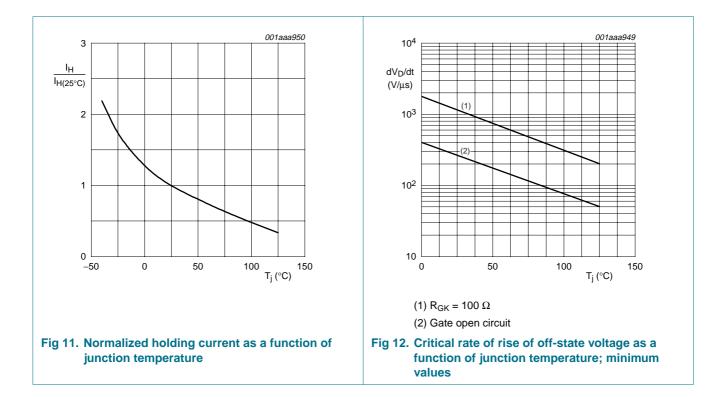
# 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ see } \frac{\text{Figure 8}}{100 \text{ mA}}$				
		BT151-500L	-	2	5	mA
		BT151-500R	-	2	15	mA
		BT151-650L	-	2	5	mA
		BT151-650R	-	2	15	mA
		BT151-800R	-	2	15	mA
IL	latching current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 100 mA; see <u>Figure 10</u>	-	10	40	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 100 mA; see <u>Figure 11</u>	-	7	20	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 23 A; see <u>Figure 9</u>	-	1.4	1.75	V
∕ <sub>GT</sub> ga	gate trigger voltage	$I_T$ = 100 mA; $V_D$ = 12 V; see <u>Figure 7</u>	-	0.6	1.5	V
		$I_T = 100 \text{ mA}; V_D = V_{DRM(max)};$ $T_j = 125 \text{ °C}$	0.25	0.4	-	V
I <sub>D</sub>	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA
I <sub>R</sub>	reverse current	$V_R = V_{RRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA
Dynamic c	haracteristics					
dV <sub>D</sub> /dt rate of rise of off-state voltage		$V_{DM} = 0.67 \times V_{DRM(max)}$ ; $T_j = 125 \text{ °C}$ ; exponential waveform; see Figure 12				
		R <sub>GK</sub> = 100 Ω	200	1000	-	V/μs
		gate open circuit	50	130	-	V/μs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 100 \text{ mA}; \text{dI}_G/\text{dt} = 5 \text{ A}/\mu\text{s}$	-	2	-	μs
tq	commutated turn-off time	$ \begin{split} &V_{DM} = 0.67 \times V_{DRM(max)}; \ T_{j} = 125 \ ^{\circ}C; \\ &I_{TM} = 20 \ A; \ V_{R} = 25 \ V; \\ &(dI_{T}/dt)_{M} = 30 \ A/\mu s; \ dV_{D}/dt = 50 \ V/\mu s; \\ &R_{GK} = 100 \ \Omega \end{split} $	-	70	-	μs

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# 7. Package outline

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DIMENS	ONS (n	nm are t	he origi	nal dime	nsions)		0		5 1ale	10 mm ]						_
UNIT	Α	A <sub>1</sub>	b	b1	с	D	D <sub>1</sub>	E	е	L	L1	L <sub>2</sub> max.	р	q	Q	
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.45 1.00	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2	
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### Fig 13. Package outline SOT78 (TO-220AB)

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# 8. Revision history

Table 6. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BT151_SER_L_R_4	20061023	Product data sheet	-	BT151_SERIES_3
Modifications:		of this data sheet has been f NXP Semiconductors.	redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the n	ew company name whe	re appropriate.
	<ul> <li>Added type</li> </ul>	numbers BT151-500L and	BT151-650L	
BT151_SERIES_3 (9397 750 13159)	20040607	Product specification	-	BT151_SERIES_2
BT151_SERIES_2	19990601	Product specification	-	BT151_SERIES_1
BT151_SERIES_1	19970901	Product specification	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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